MOSFETs Silicon N-channel MOS (U-MOSⅧ-H)

TK32A12N1

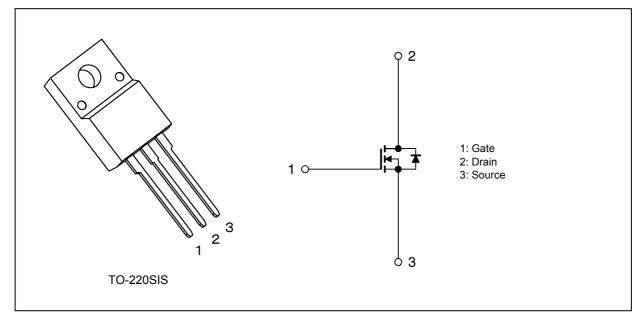
1. Applications

• Switching Voltage Regulators

2. Features

- (1) Low drain-source on-resistance: $R_{DS(ON)}$ = 11.0 m Ω (typ.) (V_{GS} = 10 V)
- (2) Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 120 \ V)$
- (3) Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 0.5 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristi	Symbol	Rating	Unit		
Drain-source voltage			V _{DSS}	120	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)	(Silicon limit)	(Note 1), (Note 2)	I _D	60	A
Drain current (DC)	(T _c = 25°C)	(Note 1)	Ι _D	32	
Drain current (pulsed)	(t = 1 ms)	(Note 1)	I _{DP}	110	
Power dissipation	(T _c = 25°C)		PD	30	W
Single-pulse avalanche energy		(Note 3)	E _{AS}	48	mJ
Avalanche current			I _{AR}	32	A
Channel temperature			T _{ch}	150	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production 2013-02

5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	R _{th(ch-c)}	4.16	°C/W
Channel-to-ambient thermal resistance	R _{th(ch-a)}	62.5	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Limited by silicon chip capability.

Note 3: V_{DD} = 80 V, T_{ch} = 25°C (initial), L = 46.1 μ H, I_{AR} = 32 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

6. Electrical Characteristics

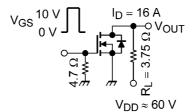
6.1. Static Characteristics (Ta = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±20 V, V_{DS} = 0 V	_	_	±0.1	μA
Drain cut-off current	I _{DSS}	V _{DS} = 120 V, V _{GS} = 0 V	_	—	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	120		_	V
Drain-source breakdown voltage (Note 4)	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	90	_	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 0.5 mA	2.0	—	4.0	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 10 V, I _D = 16 A		11.0	13.8	mΩ

Note 4: If a reverse bias is applied between gate and source, this device enters V_{(BR)DSX} mode. Note that the drainsource breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 60 V, V _{GS} = 0 V, f = 1 MHz	_	2000	—	pF
Reverse transfer capacitance	C _{rss}		_	13	—	
Output capacitance	C _{oss}		_	330	—	
Gate resistance	r _g	_	_	1.9	—	Ω
Switching time (rise time)	tr	See Figure 6.2.1	_	14	—	ns
Switching time (turn-on time)	t _{on}		_	33	—	
Switching time (fall time)	t _f		_	14	—	
Switching time (turn-off time)	t _{off}		_	43	_	



 $Duty \le 1\%, \ t_W = 10 \ \mu s$ Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

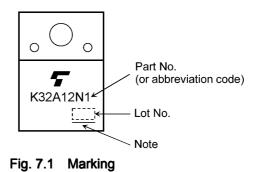
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 96$ V, V_{GS} = 10 V, I_D = 32 A	—	34	—	nC
Gate-source charge 1	Q _{gs1}		_	13	_	
Gate-drain charge	Q _{gd}		_	9.8	_	
Gate switch charge	Q _{SW}			15		

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (DC)	(Note 5)	I _{DR}	—	_	_	32	А
Reverse drain current (pulsed)	(Note 5)	I _{DRP}	—	_	—	110	
Diode forward voltage		V _{DSF}	I_{DR} = 32 A, V_{GS} = 0 V	_	—	-1.2	V
Reverse recovery time	(Note 6)	t _{rr}	I _{DR} = 32 A, V _{GS} = 0 V	_	73	_	ns
Reverse recovery charge	(Note 6)	Q _{rr}	-dI _{DR} /dt = 100 A/µs		160		nC

Note 5: Ensure that the channel temperature does not exceed 150°C. Note 6: Ensure that V_{DS} peak does not exceed V_{DSS} .

7. Marking (Note)



Note: A line under a Lot No. identifies the indication of product Labels.

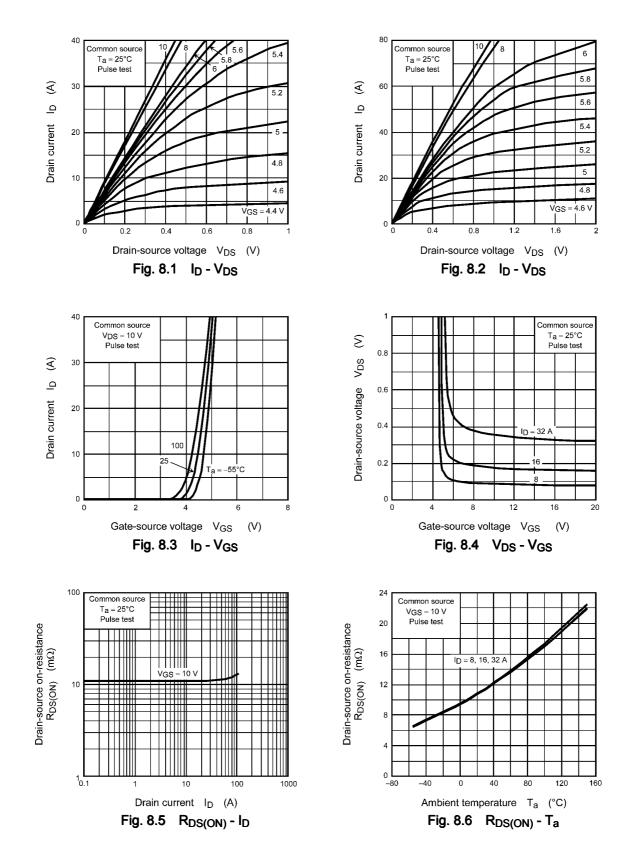
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8. Characteristics Curves (Note)



5

3

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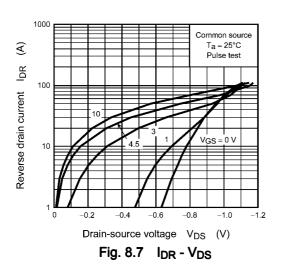
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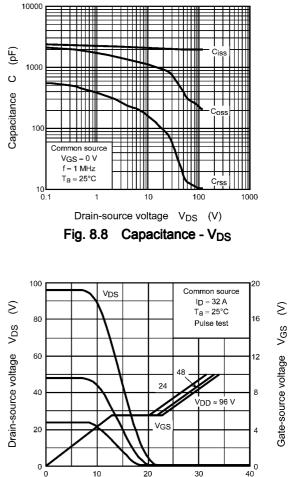
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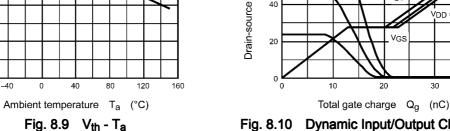
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S

Gate threshold voltage Vth





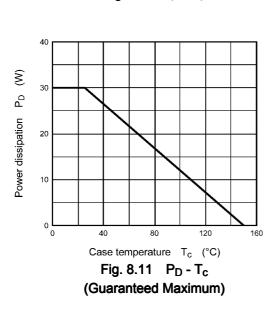


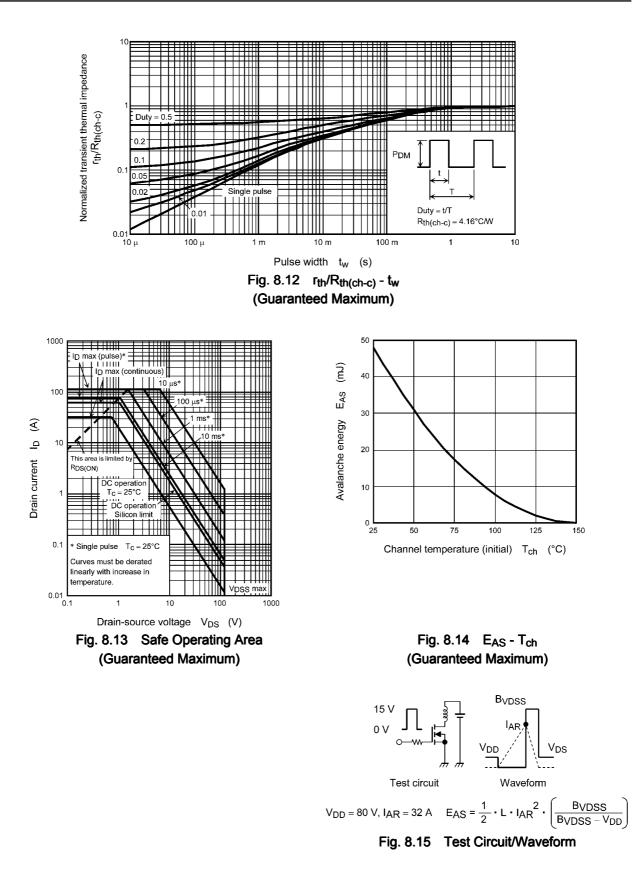
Common source

VDS = 10 V ID = 0.5 mA

Pulse test

Fig. 8.10 Dynamic Input/Output Characteristics



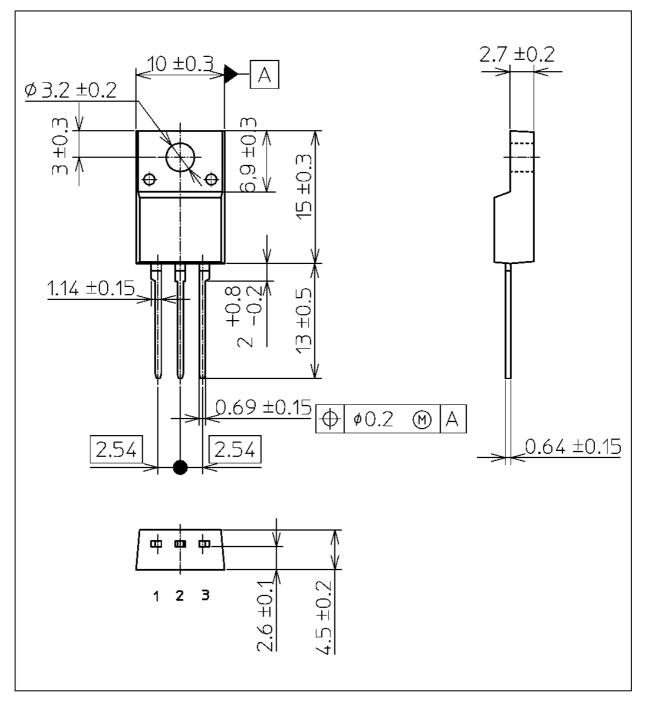


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

TK32A12N1

Unit: mm



Weight: 1.7 g (typ.)

Package Name(s)	
JEITA: SC-67	
TOSHIBA: 2-10U1S	
Nickname: TO-220SIS	

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